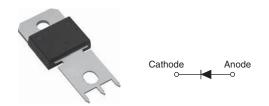


Vishay Semiconductors

### Fast Soft Recovery Rectifier Diode, 85 A

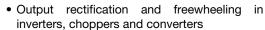


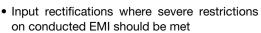
PowerTab®

| PRODUCT SUMMARY                  |                       |  |  |  |
|----------------------------------|-----------------------|--|--|--|
| Package                          | PowerTab <sup>®</sup> |  |  |  |
| I <sub>F(AV)</sub>               | 85 A                  |  |  |  |
| $V_R$                            | 1200 V                |  |  |  |
| V <sub>F</sub> at I <sub>F</sub> | 1.36 V                |  |  |  |
| I <sub>FSM</sub>                 | 110 A                 |  |  |  |
| t <sub>rr</sub>                  | 95 ns                 |  |  |  |
| T <sub>J</sub> max.              | 150 °C                |  |  |  |
| Diode variation                  | Single die            |  |  |  |
| Snap factor                      | 0.5                   |  |  |  |

#### **FEATURES**

• 150 °C max. operating junction temperature







- Screw mounting only
- Designed and qualified according to JEDEC-JESD47
- PowerTab® package
- Compliant to RoHS Directive 2002/95/EC

#### **DESCRIPTION**

The VS-85EPF12 fast soft recovery rectifier series has been optimized for combined short reverse recovery time and low forward voltage drop.

The glass passivation ensures stable reliable operation in the most severe temperature and power cycling conditions. Available in the new PowerTab® package, this new series is suitable for a large range of applications combining excellent die to footprint ratio and sturdeness connectivity for use in high current environments.

| MAJOR RATINGS AND CHARACTERISTICS |  |             |       |  |  |
|-----------------------------------|--|-------------|-------|--|--|
| SYMBOL                            | CHARACTERISTICS  | VALUES      | UNITS |  |  |
| I <sub>F(AV)</sub>                | Rect. conduction 50 % duty cycle at T <sub>C</sub> = 85 °C | 85          | ^     |  |  |
| I <sub>F(RMS)</sub>               |  | 160         | A     |  |  |
| V <sub>RRM</sub>                  | Range  | 1200        | V     |  |  |
| I <sub>FSM</sub>                  |  | 110         | А     |  |  |
| V <sub>F</sub>                    | 100 A, T <sub>J</sub> = 25 °C                              | 1.4         | V     |  |  |
| t <sub>rr</sub>                   | 1 A, - 100 A/µs  | 95          | ns    |  |  |
| T <sub>J</sub>                    | Range  | - 40 to 150 | °C    |  |  |

| VOLTAGE RATINGS |   |  |                                     |
|-----------------|---|--|-------------------------------------|
| TYPE NUMBER     | V <sub>RRM</sub> , MAXIMUM PEAK<br>REVERSE VOLTAGE<br>V | V <sub>RSM</sub> , MAXIMUM NON-REPETITIVE<br>PEAK REVERSE VOLTAGE<br>V | I <sub>RRM</sub><br>AT 150 °C<br>mA |
| VS-85EPF12      | 1200  | 1300   | 15                                  |

| ABSOLUTE MAXIMUM RATINGS                            |                    |  |        |                  |  |
|---|--------------------|--|--------|------------------|--|
| PARAMETER   | SYMBOL             | TEST CONDITIONS  | VALUES | UNITS            |  |
| Maximum average forward current                     | I <sub>F(AV)</sub> | T <sub>C</sub> = 85 °C, 180° conduction half sine wave | 85     |                  |  |
| Maximum peak one cycle non-repetitive surge current |                    | 10 ms sine pulse, rated V <sub>RRM</sub> applied       | 1100   | A                |  |
|   | IFSM               | 10 ms sine pulse, no voltage reapplied                 | 1250   |                  |  |
| Maximum I <sup>2</sup> t for fusing                 | l <sup>2</sup> t   | 10 ms sine pulse, rated V <sub>RRM</sub> applied       | 5000   | A <sup>2</sup> s |  |
|   | 1-1                | 10 ms sine pulse, no voltage reapplied 7000            |        | 7-2              |  |
| Maximum I <sup>2</sup> √t for fusing                | I <sup>2</sup> √t  | t = 0.1 ms to 10 ms, no voltage reapplied              | 70 000 | A²√s             |  |

Revision: 17-Jun-11 Document Number: 93159

# **VS-85EPF12 Soft Recovery Series**

| ELECTRICAL SPECIFICATIONS       |                    |                              |   |        |       |
|---------------------------------|--------------------|------------------------------|---|--------|-------|
| PARAMETER                       | SYMBOL             | TEST CONDITIONS              |   | VALUES | UNITS |
| Maximum forward voltage drop    | $V_{FM}$           | 85 A, T <sub>J</sub> = 25 °C |   | 1.36   | V     |
| Forward slope resistance        | r <sub>t</sub>     | - T <sub>J</sub> = 150 °C    |   | 4.03   | mΩ    |
| Threshold voltage               | V <sub>F(TO)</sub> |                              |   | 0.87   | V     |
| Maximum reverse leakage augrent |                    | T <sub>J</sub> = 25 °C       | V <sub>B</sub> = Rated V <sub>BBM</sub> | 0.1    | mA    |
| Maximum reverse leakage current | IRM                | T <sub>J</sub> = 150 °C      | v <sub>R</sub> – nateu v <sub>RRM</sub> | 15     | IIIA  |

| RECOVERY CHARACTERISTICS |                 |                                      |        |       |                            |
|--------------------------|-----------------|--------------------------------------|--------|-------|----------------------------|
| PARAMETER                | SYMBOL          | TEST CONDITIONS                      | VALUES | UNITS | · •                        |
| Reverse recovery time    | t <sub>rr</sub> | I <sub>F</sub> at 85 A <sub>pk</sub> | 480    | ns    | I <sub>FM</sub> t          |
| Reverse recovery current | I <sub>rr</sub> | 25 A/μs                              | 7.1    | Α     | $t_a \mid t_b$             |
| Reverse recovery charge  | Q <sub>rr</sub> | 25 °C                                | 2.1    | μC    | dir/<br>dt Q <sub>rr</sub> |
| Snap factor              | S               |                                      | 0.5    |       | dt $I_{RM(REC)}$           |

| THERMAL - MECHANICAL SPECIFICATIONS          |         |                                   |                                      |             |                  |
|--|---------|-----------------------------------|--------------------------------------|-------------|------------------|
| PARAMETER                                    |         | SYMBOL                            | TEST CONDITIONS                      | VALUES      | UNITS            |
| Maximum junction and sto temperature range   | orage   | T <sub>J</sub> , T <sub>Stg</sub> |                                      | - 40 to 150 | °C               |
| Maximum thermal resistar junction to case    | ice,    | $R_{thJC}$                        | DC operation                         | 0.35        |                  |
| Maximum thermal resistar junction to ambient | ice,    | R <sub>thJA</sub>                 |                                      | 40          | °C/W             |
| Typical thermal resistance case to heatsink  | ,       | R <sub>thCS</sub>                 | Mounting surface, smooth and greased | 0.2         |                  |
| Annewigante weight                           |         |                                   |                                      | 6           | g                |
| Approximate weight                           |         |                                   |                                      | 0.21        | oz.              |
| Mounting torque —                            | minimum |                                   |                                      | 6 (5)       | kgf · cm         |
|  | maximum |                                   |                                      | 12 (10)     | (lbf $\cdot$ in) |
| Marking device                               |         |                                   | Case style PowerTab®                 | 85EF        | PF12             |



#### www.vishay.com

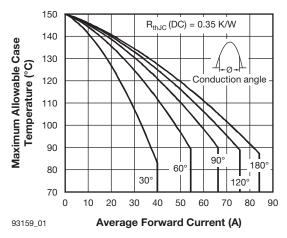


Fig. 1 - Current Rating Characteristics

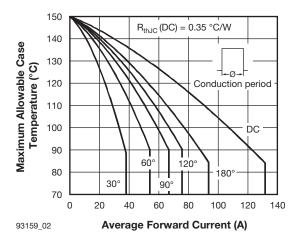


Fig. 2 - Current Rating Characteristics

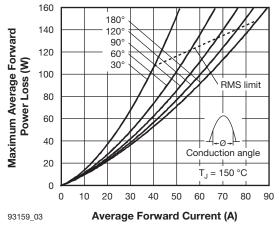


Fig. 3 - Forward Power Loss Characteristics

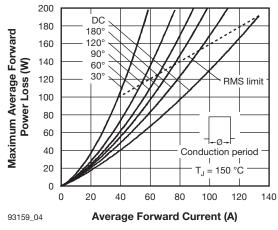


Fig. 4 - Forward Power Loss Characteristics

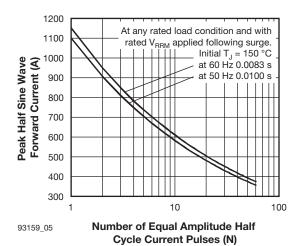


Fig. 5 - Maximum Non-Repetitive Surge Current

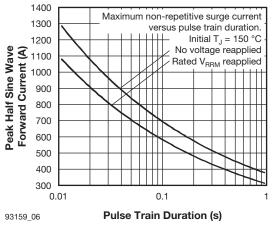


Fig. 6 - Maximum Non-Repetitive Surge Current



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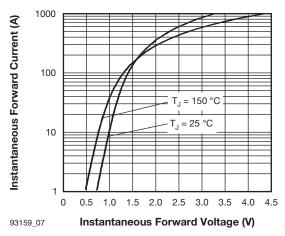
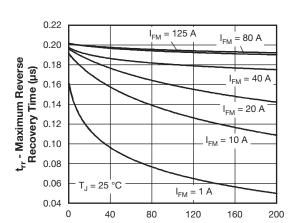
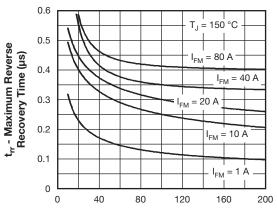


Fig. 7 - Forward Voltage Drop Characteristics



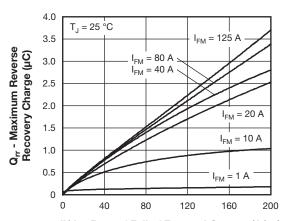
93159\_08 dl/dt - Rate of Fall of Forward Current (A/µs)

Fig. 8 - Recovery Time Characteristics, T<sub>J</sub> = 25 °C



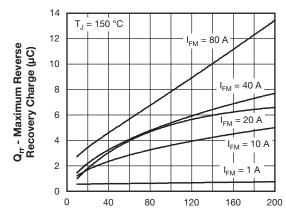
93159\_09 dl/dt - Rate of Fall of Forward Current (A/µs)

Fig. 9 - Recovery Time Characteristics,  $T_{J}$  = 150  $^{\circ}\text{C}$ 



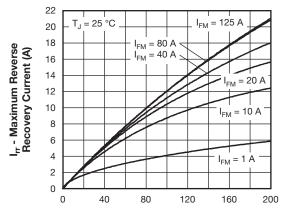
93159\_10 dl/dt - Rate of Fall of Forward Current (A/µs)

Fig. 10 - Recovery Charge Characteristics, T<sub>J</sub> = 25 °C



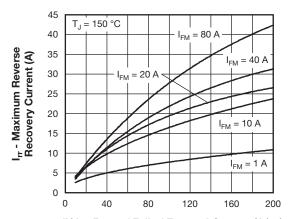
93159\_11 dl/dt - Rate of Fall of Forward Current (A/µs)

Fig. 11 - Recovery Charge Characteristics, T<sub>J</sub> = 150 °C



93159\_12 dl/dt - Rate of Fall of Forward Current (A/µs)

Fig. 12 - Recovery Current Characteristics,  $T_J = 25 \, ^{\circ}\text{C}$ 



93159\_13 dl/dt - Rate of Fall of Forward Current (A/µs)

Fig. 13 - Recovery Current Characteristics, T<sub>J</sub> = 150 °C

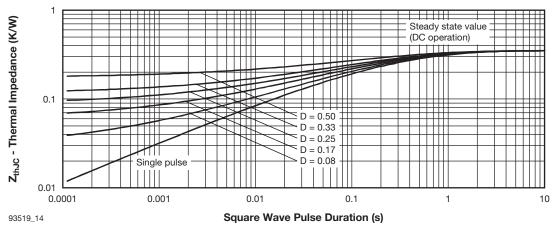


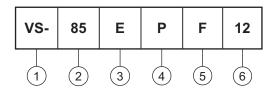
Fig. 14 - Thermal Impedance Z<sub>thJC</sub> Characteristics

## **VS-85EPF12 Soft Recovery Series**

Vishay Semiconductors

#### **ORDERING INFORMATION TABLE**

**Device code** 



1 - Vishay Semiconductors product

2 - Current rating

3 - Circuit configuration:

E = Single diode

4 - Package:

P = TO-247AC

5 - Type of silicon:

F = Fast recovery

6 - Voltage code x 100 = V<sub>RRM</sub> (12 = 1200 V)

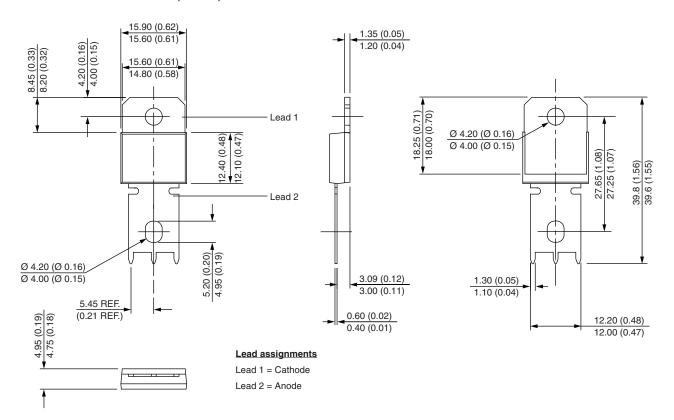
| LINKS TO RELATED DOCUMENTS                 |                          |  |  |  |
|--|--------------------------|--|--|--|
| Dimensions <u>www.vishay.com/doc?95240</u> |                          |  |  |  |
| Part marking information                   | www.vishay.com/doc?95370 |  |  |  |
| Application note                           | www.vishay.com/doc?95179 |  |  |  |



### Vishay Semiconductors

### PowerTab®

#### **DIMENSIONS** in millimeters (inches)







Vishay

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